

CLASS II FABRICATION NOTES: (UNLESS OTHERWISE SPECIFIED)

1. BOARDS SHALL BE 100% NET LIST TESTED FOR OPENS AND SHORTS PER PROVIDED IPC-D-356 NETLIST.
2. THIS BOARD SHALL BE MANUFACTURED IN ACCORDANCE WITH IPC-6012A CLASS II SPECIFICATIONS AND MEET IPC-600 CLASS II ACCEPTABILITY STANDARDS.
3. MATERIAL:

a. FR4 PER IPC 4101B/24 /26, OR /28.

b. SIGNAL LAYERS TO BE 2 OZ. COPPER.

c. PLANE LAYERS TO BE 2 OZ. COPPER.

d. OVERALL THICKNESS TO BE 0.062" +/- 0.005"
4. LEGEND:

a. WHITE NON-CONDUCTIVE EPOXY INK BOTH SIDES.
5. SOLDERMASK:

a. APPLY LIQUID PHOTO-IMAGABLE (LPI) SOLDER MASK OVER BARE COPPER PER IPC-SM-840 CLASS H, COLOR ORANGE, BOTH SIDES.
6. PLATING FINISH:

a. HOT AIR SOLDER LEVELING (HASL) SN63A SnPb SOLDER.
7. PROCESS ALLOWANCES:

a. MAXIMUM BOW AND TWIST ACROSS DIAGONAL CORNERS OF THE BOARD SHALL NOT EXCEED 0.75%.

b. HOLE DIMENSIONS APPLY AFTER PLATING.

c. ALL HOLES SHALL BE LOCATED WITHIN 0.003" DIAMETER OF TRUE POSITION.

d. LAYER TO LAYER REGISTRATION SHALL BE WITHIN 0.003".

e. CONDUCTOR WIDTHS AND SPACING SHALL BE WITHIN +/- 0.002".

f. REMOVE ALL BURRS AND BREAK SHARP EDGES 0/015" MAX.

g. CUT OUTSIDE OF 0.001" BOARD OUTLINE.

LAYER STACK - UP

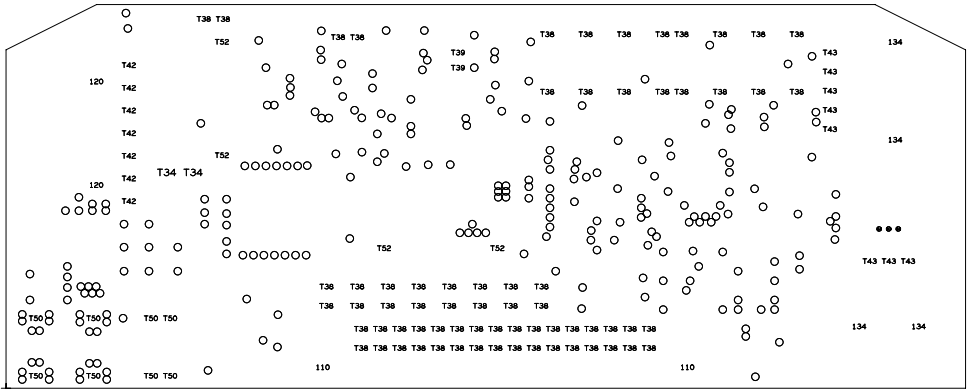
1 : TOP

2 : PWR

3 : GND

4 : BOT

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED



VISIBLE LAYERS

DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
○	10.0	PLATED	183
○	16.0	PLATED	68
●	33.0	PLATED	3
T34	34.0	PLATED	2
T38	38.0	PLATED	68
T42	42.0	PLATED	7
T43	43.0	PLATED	8
T50	50.0	PLATED	8
T52	52.0	PLATED	4
110	110.0	PLATED	2
120	120.0	PLATED	2
134	134.0	PLATED	4
T39	39.0	NON-PLATED	2

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	LOAD CONTROL ANALOG BOARD, LRAUV		
			MONTEREY BAY AQUARIUM RESEARCH INSTITUTE 7700 SANDHOLDT ROAD MOSS LANDING, CA		
	DESIGNED BY: ED MELLINGER		SIZE B	REVISION 1.0	DWG NO 10020568
	LAYOUT BY: JOSE ROSAL		SCALE 1 - 1		SHEET 1 - 1